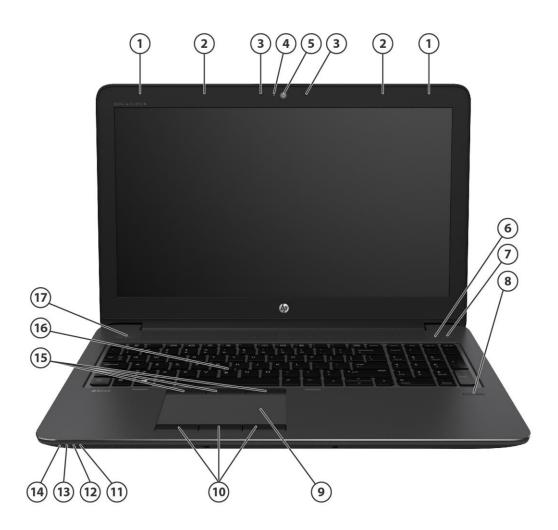
## Overview

## **HP ZBook 15 G4 Mobile Workstation**

#### **FRONT VIEW**



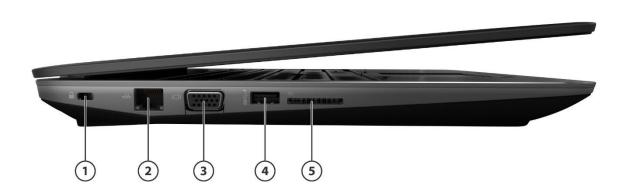
- 1. WLAN antennas (2)
- 2. WWAN antennas (optional)
- 3. Internal microphone
- 4. Webcam light (with webcam)
- 5. Webcam
- 6. Wireless button
- 7. Volume mute button
- 8. Fingerprint reader (select models only)

- 9. Touchpad with scroll zone
- 10. Lower right, center, left touchpad buttons
- 11. Storage light indicator
- 12. Battery light indicator
- 13. Power light indicator
- 14. Wireless light indicator
- 15. Upper Right, Center, Left Touchpad buttons
- 16. Pointstick
- 17. Power button



## Overview

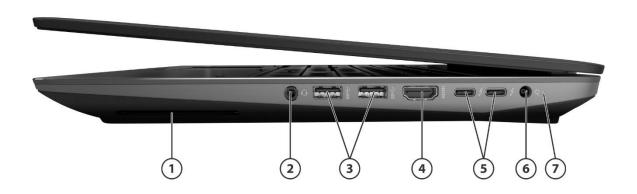
## **LEFT VIEW**



- 1. Security cable slot
- 2. RJ-45 (Ethernet)
- 3. VGA port

- 4. USB 3.0 port (charging)
- 5. SD Card reader

## **RIGHT VIEW**



- 1. Smart Card reader
- 2. Stereo microphone in / headphone-out combo jack
- 3. (2) USB 3.0 Ports
- 4. HDMI 1.4 port

- 5. (2) Thunderbolt™ 3\* ports
- 6. Power connector
- 7. Power LED

Overview

### **BOTTOM VIEW**



1. Speakers

### **Overview**

### At A Glance

- Windows® 10 editions, or FreeDOS
- Mainstream full performance industrial design, Casted magnesium-reinforced chassis, top cover frame features soft touch paint with lightweight aluminum insert anodized in HP's new "Space Silver" color with chemical etching. Backlight keyboard in full aluminum deck with magnesium bottom reinforcement, chemically strengthened glass touchpad, and updated system functions indicators. HP Spill Resistant Keyboard with Durakeys, touchpad buttons with Duracoat finish. Diamond cut process showcased around keyboard deck.
- Designed to pass Mil-Std-810G tests.
- Workstation-caliber NVIDIA® Quadro® discrete graphics: NVIDIA® Quadro® M620 (2GB GDDR5), NVIDIA® Quadro® M1200 (4GB GDDR5), AMD RadeonPro™ WX 4150 (4GB GDDR5), NVIDIA® Quadro® M2200 (4GB GDDR5); NVIDIA® Optimus or AMD Enduro™ technology.
- Intel Integrated graphics: Intel® HD Graphics 530 integrated on Core™ i7. Intel® HD Graphics P530 on Xeon® processors.
- ISV certified to provide fast and reliable performance with workstation applications, including manipulation of 3D textures.
- Choice of 7<sup>th</sup> generation Intel<sup>®</sup> Core<sup>™</sup> i7 and i5 quad-core or Xeon<sup>®</sup> processors.
- Intel® Core™ i7 with vPro, Intel Core™ i5 with vPro technology or Intel Xeon® with vPro technology (optional)
- HP Performance Advisor for optimal configuration, compatibility and performance
- Up to four SODIMMs, for system memory up to 64 GB. ECC memory with Intel Xeon® processors.
- Supports multi-display, including up to four (4) displays without a docking solution, with hybrid graphics enabled.
   Supports up to six (6) displays with HP Zbook Dock with Thunderbolt™ 3 (sold separately), with hybrid graphics enabled.
- Two (2) Thunderbolt<sup>™</sup> 3 ports (supporting DisplayPort 1.2, USB 3.1, PCle Gen 3 devices) on the new USB-C<sup>™</sup> connector, for high speed data/video/audio transfer support.
- Bang and Olufsen audio optimized for high fidelity audio with immersive surround sound with deep, rich bass and crystal clear dialog without distortion at high volume
- Long life battery solution: 9-cell (90 WHr)
- 2 discrete buttons with LED indicator for convenient one touch access Wireless On/Off, Volume Mute
- Widescreen 15.6-inch diagonal anti-glare LED-backlit display:
   FHD (1920x1080) standard viewing angle, FHD (1920x1080) ultrawide viewing angle, or UHD (3840x2160) ultrawide viewing angle with HP DreamColor Technology, or FHD Touch (1920x1080) ultrawide viewing angle.
- Wireless connectivity options:
  - Intel® Dual Band Wireless-AC 8265 802.11 AC/a/b/g/n (2x2) WiFi and Bluetooth® 4.2 combo adaptor (vPro) or Intel® Dual Band Wireless-AC 8265 802.11 AC/a/b/g/n (2x2) WiFi and Bluetooth® 4.2 combo (non-vPro)
  - o Optional integrated wireless 3G or 4G (LTE) mobile broadband module support
- Three dedicated drive slots. (2) M.2 slots and (1) 2.5" drive bays.
- Security features including HP Client Security Manager, managed via single console.
- Low halogen
- HP BIOS technology, including HP Sure Start to identify and recover from unknown BIOS attacks.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



#### **Features**

### **OPERATING SYSTEM**

**Preinstalled** Windows® 10 Pro 64<sup>1</sup>

Windows® 10 Home 641

Windows® 10 Home Single Language 641

FreeDOS 2.0

**Supported** Windows® 10 Enterprise 64<sup>1</sup>

Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately
purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10
is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over
time for updates. See <a href="http://www.microsoft.com">http://www.microsoft.com</a>

**NOTE**: In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com

### PROCESSOR\*

Intel® Xeon®E3-1535M v6 with Intel® HD graphics P630 (3.10 GHz, 2400 MHz, 8MB L3 cache, 4 Cores, 45W) Up to 4.20 GHz with Intel® Turbo Boost Technology

Intel® Xeon® E3-1505M v6 with Intel® HD graphics P630 (3.00 GHz, 2400 MHz, 8 MB L3 Cache, 4 Cores, 45W) Up to 4.00 GHz with Intel® Turbo Boost Technology

Intel® Core™ i7-7820HQ with Intel® HD graphics 630 (2.90 GHz, 2400 MHz, 8 MB L3 Cache, 4 Cores, 45W) Up to 3.90 GHz with Intel® Turbo Boost Technology

Intel® Core™ i7-7700HQ with Intel® HD graphics 630 (2.80 GHz, 2400 MHz, 6 MB L3 Cache, 4 Cores, 45W) Up to 3.80 GHz with Intel® Turbo Boost Technology

Intel® Core™ i5-7440HQ with Intel® HD graphics 630 (2.80 GHz, 2400 MHz, 6 MB L3 Cache, 4 Cores, 45W) Up to 3.80 GHz with Intel® Turbo Boost Technology

Intel® Core™ i5-7300HQ with Intel® HD graphics 630 (2.50 GHz, 2400 MHz, 6 MB L3 Cache, 4 Cores, 45W) Up to 3.50 GHz with Intel® Turbo Boost Technology

\*Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance.

Also note that the Intel® Turbo Boost is based on max GHz for a single core.

## **CHIPSET**

Mobile Intel® CM238



**Features** 

## INTEL® CORE™ I5 WITH VPRO/CORE I7 WITH VPRO/XEON® WITH VPRO TECHNOLOGY CAPABLE

Intel® Core™ i5 with vPro™, Core™ i7 with vPro™ and XEON® with vPro™ technology is a selectable feature that is available on units configured with select processors, a qualified Intel® Centrino® WLAN module and a preinstalled Windows® operating system. It provides advances in remote manageability, security, energy efficient performance, and wireless connectivity. Intel® Active Management Technology (iAMT) offers built-in manageability and proactive security for networked mobile workstations, even when they are powered off\* or when the operating system is inoperable. It can help identify threats before they reach the network, isolate infected systems, and update regardless of their power state.

\* Requires a Windows operating system, network hardware and software, connection with a power source, and a direct (non-VPN) corporate network connection which is either cable or wireless LAN.

**NOTE:** Some functionality of Intel® Core™ i5 with vPro™/Core™ i7 with vPro™/Xeon® with vPro™ technology, such as Intel® Active Management technology and Intel® Virtualization technology, requires additional third- party software in order to run. Availability of future "virtual appliances" applications for Intel® Core™ i5 with vPro™/Core i7 with vPro™/XEON® with vPro™ technology is dependent on third- party software providers. Compatibility with future "virtual appliances" is yet to be determined.

### **GRAPHICS**

#### **Intel Integrated**

Intel® HD graphics 630<sup>1</sup>; Intel® HD graphics P630<sup>1</sup>;

**NOTE 1:** HD content required to view HD images.

NOTE 2: Available in hybrid graphics mode only with NVIDIA graphics

#### Discrete

AMD RadeonPro™ WX 4150 with 4 GB dedicated GDDR5 video memory Microsoft DirectX 12 (Shader Model 5.0) and OpenGL 4.4 capable

NVIDIA® Quadro® M1200 with 4 GB dedicated GDDR5 video memory Microsoft DirectX 12 (Shader Model 5.0) and OpenGL 4.4 capable

NVIDIA® Quadro® M2200 with 4 GB dedicated GDDR5 video memory Microsoft DirectX 12 (Shader Model 5.0) and OpenGL 4.4 capable

**NOTE**: NVIDIA® Quadro® mobile professional graphics support up to four independent displays when using a HP ZBook Dock with Thunderbolt™ 3 (sold separately) or DP 1.2 hubs with MST. AMD RadeonPro™ professional graphics support up to six independent displays when using an HP ZBook Dock with Thunderbolt™ 3 (sold separately) or DP 1.2 hubs with MST.

NVIDIA® Optimus Technology and AMD Enduro™ Technology supported

NOTE 1: Color management on UHD DreamColor panels is not supported while NVIDIA® Optimus Technology is activated.



#### **Features**

#### DisplayPort 1.2 protocol features supported on Thunderbolt™ 3 ports:

- Legacy displays (HDMI, DVI, VGA) may be attached to Thunderbolt™ port with the use of a certified dongle.
- DisplayPort monitors capable of supporting DisplayPort 1.2 may be directly attached to the Thunderbolt™ port to achieve HBR2 with the use a dongle.
- DisplayPort monitors capable of supporting DP 1.2 may be directly attached to the Thunderbolt™ port to achieve HBR2 with the use a dongle.
- Thunderbolt™ 3 enabled monitors may be directly attached to the Thunderbolt™ port to achieve HBR2 and MST.
- DisplayPort 1.2 MST feature ("daisy-chain" feature) is supported through Thunderbolt™ 3 port on Thunderbolt™ 3
   enabled devices or DisplayPort 1.2 monitors (requires monitor with DisplayPort 1.2 MST capability) with the use of a
   dongle.
- Up to 2 streams (eight lanes) of DisplayPort 1.2 are supported over a single Thunderbolt™ 3 port. Up to (2) 4K displays 24/30-bit color depth at 60 Hz or (1) 5K display supported over a single Thunderbolt™ 3 port. (Requires Intel certified Thunderbolt™ cable).
- DisplayPort 1.2 w/MST (Multi-stream Transport): Supports resolutions up to Full 4K, 24/30-bit color depth at 60 Hz, and WUXGA (1920 x1200) monitors, 24/30-bit color depth at 120 Hz.

\*Thunderbolt™ 3 is superset port supporting DisplayPort 1.2, USB 3.1 Gen 2, and PCIe Gen 3 devices over the new USB-C™ connector. Install all the latest drivers for your Thunderbolt™ device before connecting the device to the Thunderbolt™ port. Thunderbolt™ cable and Thunderbolt™ device (sold separately) must be compatible with Windows. To determine whether your device is Thunderbolt™ Certified for Windows, see https://Thunderbolttechnology.net/products.

#### **Multi-Display Support**

#### Without ZBook Dock with Thunderbolt™ 3:

HP ZBook 15 with hybrid graphics and without the use of the ZBook dock supports up to a maximum of four independent displays. These four displays are the internal panel plus three external displays connected to the VGA and two of the three following ports: HDMI 1.4, Thunderbolt™ 3, Thunderbolt™ 3. HP ZBook 15 configuration with Intel integrated graphics and without the use of the ZBook dock supports up to a maximum of three independent displays. Any three display combination of the system panel, VGA, and two of the three following ports: HDMI, Thunderbolt™ 3, Thunderbolt™ 3.

#### With ZBook Dock with Thunderbolt™ 3:

The ZBook Dock with Thunderbolt<sup>™</sup> 3 dock has Thunderbolt<sup>™</sup> 3 port, VGA, and two DisplayPort 1.2. When used together with the HP ZBook 15 configuration with hybrid graphics, a maximum of 6 independent displays are supported. These six displays are internal panel, one external display connected to the system's VGA port and four external displays connected to the ZBook dock's Thunderbolt<sup>™</sup> 3, VGA, and two DisplayPort ports. When used together with the HP ZBook 15 configuration with Intel integrated graphics, a maximum of 3 independent displays are supported. Any three display combination of the system panel, system ports and ZBook Dock ports.

## Without ZBook Dock with Thunderbolt™ 3 (using DP 1.2 MST)

Multi-stream Transport is a DP 1.2 feature that allows daisy chaining of DP 1.2 monitors that are Thunderbolt™ 3 enabled (requires built in support of DP 1.2 MST in monitor), or the use of DP 1.2 hubs (Thunderbolt™ 3 enabled) with MST to achieve 6 active displays without a docking station on configurations with hybrid graphics enabled.

\* HP ZBook Dock with Thunderbolt™ 3 sold separately.



#### **Features**

### **DISPLAY**

#### Internal

15.6" diagonal LED backlit FHD UWVA IPS eDP anti-glare + PSR (Panel Self Refresh) (1920 x 1080);

15.6" diagonal LED backlit FHD SVA eDP anti-glare (1920 x 1080);

15.6" diagonal LED UHD UWVA IPS anti-glare DreamColor (3840 x 2160)

15.6" diagonal Touch LED-backlit FHD UWVA IPS (1920 x 1080)

#### **External**

Up to 30-bit (2^30) per pixel "Deep Color" (total of 1,073,741,824 color variations)

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.

## STORAGE AND DRIVES

### (1) 2.5" Storage Bay Drives\*

1 TB 5400 rpm SATA 500 GB 7200 rpm SATA 500 GB SATA SSHD (Hybrid Drive) (8 GB cache) 500 GB 7200 rpm SATA SED (Self Encrypting Drive) 500 GB 5400 rpm SATA FIPS 140-2 SED Drive 256GB SATA SSD

#### (2) M.2 SATA SED Solid State DriveS\*

256 GB SATA Self Encrypting Drive(SED) 512 GB SATA Self Encrypting Drive(SED)

## **HP 3D DriveGuard (Windows only)**

The hard drive is mounted directly to the notebook frame, reducing the transmission of shock to the hard drive. Uses three-axis digital motion detection with intelligent sensitivity to help protect the hard drive during normal use from shock and vibration. The digital accelerometer temporarily halts all data transfer and parks the hard drive when abrupt motion is detected.

### **HP Z Turbo Drives (NVMe PCIe SSD)**

256GB PCIe (NVMe) TLC Solid State Drive 256GB PCIe (NVMe) MLC Solid State Drive 512GB PCIe (NVMe) MLC Solid State Drive 512GB PCIe (NVMe) TLC Opal 2 Solide State Drive 1TB PCIe (NVMe) MLC Solid State Drive

\*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.



#### **Features**

### **DRIVE CONTROLLERS**

2.5" Storage Bays and M.2 Storage Bay (SATA): SATA-3 or SATA-2 for HDD and SATA-3 for SSD

HP Z Turbo Drive: PCIe NVMe SSD RAID: 0,1 supported\*

**NOTE:** Raid 0, 1 supported only on SATA drives.

### **MEMORY**

#### Standard

64 GB DDR4 1.2V ECC or Non-ECC SDRAM (With transfer rates up to 2400MT/s) Four SODIMM slots supporting dual-channel memory 4 GB, 8GB and 16 GB SODIMMs (for Intel® Core™ Processors) 8GB and 16 GB ECC SODIMMs (for Intel® XEON® Processors)

#### Maximum

Upgradeable to 65536 MB with optional 16384 MB SODIMMs in all 4 slots

#### **Dual-channel**

Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory channels.

**NOTE:** Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed. Maximum memory capacities assume Windows 64-bit operating systems. With Windows 32-bit operating systems, memory above 3GB may not all be available due to systems

## **NETWORKING/COMMUNICATIONS**

#### Communications\*

Intel® I219-LM Gigabit\* Network Connection (vPro configurations)

#### **Wireless**

Support for a broad range of secure, integrated wireless LAN and wireless WAN options featuring support for the latest industry standards. Optional Broadband Wireless (WWAN) requires a Windows® operating system and is available in select countries as a standard, factory configurable feature only. Integrated Bluetooth® is also available (factory configurable only) and can be combined with any of the supported wireless LAN and wireless WAN options.

#### 802.11 Wireless LAN options\*\*

Intel® Dual Band Wireless-AC 8265 802.11 a/b/g/n/ac (2x2) WiFi and Bluetooth® 4.2 combo (vPro) Intel® Dual Band Wireless-AC 8265 802.11 a/b/g/n/ac (2x2) WiFi and Bluetooth® 4.2 combo (non-vPro)

#### Wireless WAN - Mobile Broadband options\*\*\*

HP lt4120 Qualcomm® Snapdragon™ X5 LTE Mobile Broadband Module (optional) HP lt4132, LTE/HSPA+ 4G Mobile Broadband Module (optional) HP hs3210 HSPA+ Mobile Broadband Module (optional)



#### **Features**

\*The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

\*\*Wireless cards are optional or add-on features and requires separately purchased wireless access point and internet service. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.

\*\*\* WWAN use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, and in all regions.



#### **Features**

## **AUDIO/MULTIMEDIA**

#### Audio

Bang and Olufsen HD audio Integrated stereo speakers Integrated microphone (dual-microphone array when equipped with optional webcam) Button for volume mute; function keys for volume up and down Combo mic-in / stereo headphone-out jack

#### Webcam

Optional 720p HD webcam\*

- HD format (widescreen)
- Supports videoconferencing and still image capture
- High quality fixed focus lens
- Video capture at various resolutions up to 1280x720 resolution (720p) and up to 30fps
- M-JPEG compression supports higher frame rates for video capture and videoconferencing
- · Improved low light sensitivity
- Improved dynamic range

## **KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS**

### Keyboard

Backlit keyboard with Function key control to toggle backlit brightness setting - off/full/half brightness
The HP spill-resistant keyboard is designed using a thin layer of Mylar film under the keyboard and a drain system that
funnels fluid through a hole in the bottom of the notebook. This minimizes the risk of damage to sensitive components
underneath. The 100-key compatible keyboard features a full-pitch key layout with desktop keyboard features, such as
editing keys, both left and right control and alt keys, function keys, and 18.7 x 18.4 mm key pitch (center-to-center spacing).
U.S. and International key layouts are available. Other features include hot keys for instant access to power conservation and
brightness.

#### **Pointing Devices**

Touchpad with On/Off button, two-way scroll, gestures, three pick buttons
Pointstick with three additional pointstick buttons
Image sensor touchpad for enhanced performance and improved precision on scroll and gesture

#### **Buttons and Function Keys**

Separate launch buttons provide easy access to the following features: wireless on/off, volume mute. Function keys provide control of the following features: standby mode, external display, volume down, volume up, and display brightness.



<sup>\*</sup> HD content required to view HD images.

#### **Features**

### **SOFTWARE AND SECURITY**

#### Preinstalled Software with Windows® Operating System

#### BIOS

HP BIOSphere Gen31

HP Sure Start Gen3<sup>2</sup>

HP DriveLock | HP Automatic DriveLock

**BIOS Update via Network** 

**Master Boot Record Security** 

Power On Authentication

Secure Erase<sup>3</sup>

Absolute Persistence Module<sup>4</sup>

**Pre-boot Authentication** 

**HP LAN-WLAN Protection** 

#### Multi Media

Cyberlink Power MediaPlayer CMIT

### **Communication / Connectivity**

HP Mobile Connect Pro⁵

Native Miracast Support<sup>6</sup>

HP MAC Address Manager (select models only)

HP Wireless Wakeup (select models only)

**HP SureConnect** 

#### **HP Value Add Software**

HP 3D DriveGuard 6

HP ePrint Driver + JetAdvantage<sup>7</sup>

**HP Hotkey Support** 

**HP Recovery Manager** 

**HP Jumpstart** 

HP Support Assistant<sup>12</sup>

**HP Noise Cancellation Software** 

**HP Performance Advisor** 

**HP Remote Graphics Software** 

**HP Velocity** 

#### **Microsoft Products**

**Buy Office** 

**Bing Search** 

Skype<sup>8</sup>

#### Manageability

HP Driver Packs 9

HP SoftPaq Download Manager (SDM)

HP System Software Manager (SSM) 9

HP BIOS Config Utility (BCU) 9

HP Client Catalog 9

HP Manageability Integration Kit for Microsoft SCCM 10

**HP Image Assistant** 

LANDESK Management 11

Discover HP Touchpoint Manager<sup>13</sup>

For more information on HP Client Management Solutions refer to: http://www.hp.com/go/clientmanagement.



#### **Features**

#### **Client Security Software**

- HP Client Security Suite Gen3<sup>14</sup>
- HP Security Manager (including Credential Manager and Password Manager)
- HP Fingerprint Sensor
- Power On Authentication
- Device Access Manager

Microsoft Defender 15 HP WorkWise16

#### **Standard**

For Windows 10, Trusted Platform Module (TPM) 2.0 (Infineon SLB9670). Common Criteria EAL4+ Certified.

**HP Fingerprint Reader** 

For more information on HP Client Security Software Suite, refer to http://www.hp.com/go/clientsecurity.

- 1. Requires Intel® 7th generation processors
- 2. Available on HP Elite products equipped with Intel® 7th generation processors.
- 3. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88.
- 4. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/ computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.
- 5. HP Mobile Connect Pro is only available on preconfigured devices with WWAN. For geographic availability refer to http://www.hp.com/go/mobileconnect
- 6. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information: http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast
- 7. Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see http://www.hp.com/go/eprintcenter). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary.
- 8. Skype is not offered in China.
- 9. Not preinstalled, however available for download at http://www.hp.com/go/clientmanagement
- HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html
- 11. Subscription required.
- 12. Requires Windows and Internet Access
- 13. HP Touchpoint Manager requires purchase of a subscription and supports Android™, iOS and Windows 7 or higher operating systems and PCs, notebooks, tablets and smartphones from various manufacturers. Not available in all countries see www.hp.com/touchpoint for availability information
- 14. Requires Windows and Intel® 7th generation processors.
- 15. Opt in and internet connection required for updates
- 16. HP WorkWise smartphone app is available as a free download on the App Store and Google Play

### **Workstation ISV Certifications**



#### **Features**

See the latest list of certifications at: http://www.hp.com/go/isv

#### **HP Remote Graphics Software**

The remote desktop solution for serious workstation users and their most demanding applications.

Download at: http://www.hp.com/go/RGS

#### **HP Performance Advisor**

HP Performance Advisor enables optimal configuration of HP Mobile Workstations delivering stability and best performance. HP Performance Advisor will guide your system setup allowing a "custom" configuration that best matches the workstation to user requirements.

Download at: http://www.hp.com/go/performanceadvisor

### Security

See Software section above.

### **Other Standard Security Features**

Integrated Smart Card Reader One-Step Logon Security lock slot Support for Intel® AT

#### **Optional Security Features**

**HP Fingerprint Sensor (optional)** 

Absolute Data Protect\* with GPS Tracking - Subscription based security solution providing the ability to track, initiate physical recovery, conduct asset management, and perform remote data delete by utilizing GPS technology. GPS functionality requires HP Mobile Broadband Module.

\* The Absolute Data Protect agent is shipped turned off, and must be activated by customers when they purchase a subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S.



### **Features**

### **HP CENTRAL MANAGEMENT**

HP offers a variety of scalable hardware, software, and BIOS-based security features to help you defend your organization against viruses and other threats. These integrated security features safeguard what matters to you the most - your data, device and identity. Now, be confident your fleet of devices is protected in multiple layers of HP Client Security protection.

HP BIOS Protection keeps you up and running with enhanced protection against virus attacks and other threats. And if the BIOS is accidently compromised, the auto recovery feature automatically restores it to its fully functional state.

HP Sure Start detects and negates a BIOS attack with automatic recovery of the BIOS even when the installation is accidentally compromised (i.e. power outage). When HP Sure Start heals the BIOS an event log is generated that an IT administrator can retrieve so the business is aware of a BIOS attack. Golden copy of BIOS is stored in protected nonvolatile memory providing redundant, hardware-based protection against a new generation of attacks. This helps to future-proof your technology and business.

An optional fingerprint reader and integrated Smart Card Reader help keep your identity secure. The security cable slot helps keep your notebook physically secure.

You can even permanently destroy data on your hard drive in preparation for your system disposal or redeployment with Secure Erase.



#### Features

## **POWER**

### **Power Supply**

HP 150W Slim Smart AC adapter (153 x 66 x 22 mm)

#### **Primary Battery**

HP Long Life 9-cell Polymer Battery (90 WHr) \*

### **Battery Life**

Battery life up to 17 hours 30 minutes (with 90Whr battery, FHD panel, Z Turbo Drive, Intel graphics)\*\*
Battery life up to 17 hours 26 minutes (with 90Whr battery, FHD panel, Z Turbo Drive; NVIDIA M1200, Hybrid graphics)\*\*

### **System Standby Time**

Up to TBD weeks\*\*\*

- \* Available with 3-year limited warranty only
- \*\* Battery life will vary depending on the product model, configuration, loaded applications, features, use, wireless functionality and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See MobileMark14 battery benchmark https://bapco.com/products/mobilemark-2014/ for additional details.
- \*\*\* Standby life will vary depending on various factors including battery, Memory, CPU, EC and LAN chip. The maximum capacity of the battery will naturally decrease with time and usage.

#### **Power Conservation**

NVIDIA® Optimus or AMD Enduro™ technology Hibernation Standby ACPI compliance

### **ENVIRONMENTAL**

US ENERGY STAR ® IT ECO declaration EPEAT® registered\* Low Halogen\*\*

- \* EPEAT ® registered where applicable. EPEAT registration varies by country. See www.epeat.net for registration status by country. See HP's 3rd party option store for solar energy accessory www.hp.com/go/options.
- \*\*External power supplies, power cords, cables and peripherals are not low halogen. Service parts obtained after purchase may not be low halogen.

## **WEIGHTS & DIMENSIONS**

### Weight

Starting at 5.7 lb. (2.60kg.)

**Dimensions** (w x d x h) 15.2 in x 10.4 in x 1.0 in



#### **Features**

386 mm x 264 mm x 26 mm

**NOTE:** Height varies depending upon where on the notebook the measurement is made. Weight varies by configuration and components. Weight includes Quad Core CPU, FHD, Intel® HD graphics, 8GBx1 SODIMM, HP Z Turbo Drive, wLAN/BT, FPR, 9-cell battery, no wWAN.

## **PORTS/SLOTS**

#### **Ports**

#### Left side:

- (1) RJ-45 (Ethernet)
- (1) VGA
- (1) USB 3.0 Charging Port
- (1) Security lock slot

#### Right side:

- (1) HDMI 1.4
- (2) Thunderbolt™ 3\* (Supporting DisplayPort 1.2, USB 3.1 Gen2, PCIe Gen 3 devices)
- (1) Stereo microphone in / headphone-out combo jack
- (1) Power Connector
- (2) USB 3.0

#### Thunderbolt™ 3

Thunderbolt<sup>™</sup>3 ports supports DisplayPort 1.2, USB 3.1 Gen 2, and PCIe Gen 3 devices over the new USB-C port connector. The port is compatible with existing DisplayPort displays, devices, and cables. Install all the latest drivers for your Thunderbolt<sup>™</sup> device before connecting the device to the Thunderbolt<sup>™</sup> port. Thunderbolt<sup>™</sup> cable and Thunderbolt<sup>™</sup> device (sold separately) must be compatible with Windows<sup>®</sup>. To determine whether your device is Thunderbolt<sup>™</sup> Certified for Windows, see <a href="https://thunderbolttechnology.net/products">https://thunderbolttechnology.net/products</a>.

## **Digital Media Slots**

- (1) SD UHS-II Flash Media slot (Supports next generation SD (Secure Digital), backward compatible to SDHC, SDXC.
- (1) Integrated Smart Card Reader (Compatible with ISO 7816 compliant Smart Cards PC/SC interface support)

### SERVICE AND SUPPORT

Limited 3-year or 1-year limited warranty options available, depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Optional\* HP Care Pack Services are extended service contracts which go beyond your standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at <a href="http://www.hp.com/go/cpc">http://www.hp.com/go/cpc</a>.

\*Sold separately or as an optional feature. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product. Consult your local HP Customer Support Center for details.



## Technical Specifications – System Unit

### **SYSTEM UNIT**

**Stand-Alone Power Nominal Operating** 19.5 V

Requirements (AC Power) Voltage

Average Operating Power DreamColor 25W (Windows® 10 64-bit)

Without DreamColor 16.8 W (Windows® 10 64-bit)

Max Operating Power < 150 W

**Temperature Operating** 32° to 95° F (0° to 35° C)

**Non-operating**  $-4^{\circ}$  to  $140^{\circ}$  F ( $-20^{\circ}$  to  $60^{\circ}$  C)

**Relative Humidity Operating** 10% to 90%, non-condensing

Non-operating 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

**Shock Operating** 40 G, 2 ms, half-sine

**Non-operating** 200 G, 2 ms, half-sine

**Random Vibration Operating** 0.75 grms

Non-operating 1.50 grms

**Altitude** (unpressurized) **Operating** -50 to 10,000 ft (-15.24 to 3,048 m)

**Non-operating** -50 to 40,000 ft (-15.24 to 12,192 m)

Industry Standard Certifications UL Yes
CSA Yes
FCC Compliance Yes

**ENERGY STAR®** Select models\*

EPEAT Gold \*\*
ICES Planned
Australia / Planned

**NZ A-Tick Compliance** 

CCC Planned

Japan VCCI Compliance Planned

KC Planned

BSMI Planned

CE Marking Compliance Planned

MIL STD 810G Planned\*\*\*

For accessibility information on HP products, please visit: http://www.hp.com/accessibility.



<sup>\*</sup> Configurations of the HP ZBook 15 G4 that are ENERGY STAR® qualified are identified as HP ZBook 15 G4 ENERGY STAR® on HP websites and on http://www.energystar.gov.

<sup>\*\*</sup> EPEAT® registered where applicable. EPEAT registration varies by country. See http://www.epeat.net for registration status by country. See HP's 3rd party option store for solar energy accessory www.hp.com/go/options.

<sup>\*\*\*</sup> MIL STD 810G testing is pending and is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Damage under the MIL STD test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack. For accessibility information on HP products, please visit:

## **HP ZBook 15 G4 Mobile Workstation**

## Technical Specifications - Displays

### **DISPLAYS**

15.6" diagonal LEDbacklit FHD UWVA IPS eDP anti-glare + Panel Self Refresh (PSR) (1920 x 1080) **Active Area** (W x H) 13.54 x 7.59 in (34.4 x 19.4 cm)

Dimensions (W x H)15.6 in (39.6 cm)Weight360 g (max)Surface TreatmentAnti-glareContrast Ratio600:1 (typical)

Refresh Rate 60 Hz

**Brightness\*** 300 nit typical

Pixel Resolution Format 1920 x 1080 (FHD)

**Configuration** RGB Stripe

**Backlight** LED **PPI** 141

Viewing Angle 85/85/85 (Left/Right/Down/Up) (typical)

\* All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower."

15.6-inch diagonal LED Active Area (W x H)
backlit FHD SVA eDP antiglare + Panel Self
Refresh (PSR) (1920 x
1080) Weight
Surface Treatment

**Active Area** (W x H) 13.54 x 7.59 in (34.4 x 19.4 cm)

Dimensions (W x H)15.6 in (39.6 cm)Weight380 g (max)Surface TreatmentAnti-glareContrast Ratio400:1 (typical)

Refresh Rate 60 Hz

**Brightness\*** 300 nit typical

Pixel Resolution Format 1920 X 1800 (FHD)

**Configuration** RGB Stripe

BacklightLEDPPI141

Viewing Angle 45/45/35/25 (Left/Right/Down/Up) (typical)

\* All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower."

15.6-inch UHD UWVA IPS Dimensions (W x H)
LED anti-glare + Panel Diagonal Size
Self Refresh (PSR)
Dreamcolor (3840x2160)
Weight

**Dimensions** (W x H) 13.62 x 7.59 in (3.6 x 19.4 cm)

Diagonal Size15.6 in (39.6 cm)Weight345 g (max)Surface TreatmentAnti-glareContrast Ratio1000:1 (min)Refresh Rate60 Hz

Brightness\* 270 nit typical

**Pixel Resolution** Pitch 0.090 x 0.090 mm

Format 3840x2160 Configuration RGB Stripe

Backlight LED



# **Technical Specifications - Displays**

**PPI** 282

Viewing Angle 85/85/85 (Left/Right/Down/Up) (typical)

\* All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower."

15.6-inch FHD TOUCH

UWVA IPS LED (1920x1080) **Dimensions** (W x H) 13.62 x 7.59 in (36 x 22.4 cm max)

Diagonal Size15.6 in (39.6 cm)Weight345 g (max)Surface TreatmentAnti-glareContrast Ratio600:1 (typ)Refresh Rate60 HzBrightness\*300 nit typ

Pixel Resolution Format 1920 x 1080 (FHD)

**Configuration** RGB Stripe

Backlight LED PPI 142

Viewing Angle 85/85/85 (Left/Right/Down/Up) (typical)

\* All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower."



# Technical Specifications - Storage and Drives

### STORAGE AND DRIVES

**Internal Storage** 

**1 TB 5400 rpm SATA Hard Drive Weight** 0.21 lbs (94 g)- 0.21 lbs (95 g)

Drive

 Capacity
 1 TB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate Synchronous (maximum) 600 MB/s
Seek Time Single Track 2 ms

(typical reads, including Average 12 ms-13 ms

settling)

Maximum 18 ms-22 ms

CacheUp to 32MBRotational Speed5400 rpmLogical Blocks1,953,525,168

**Operating Temperature** 32° to 140° F (0° to 60° C) [case temp] **Features** ATA Security, S.M.A.R.T., NCQ, Ultra DMA

500 GB 7200 rpm SATA Hard Drive **Drive Weight** 0.20 lbs (92 g) ~ 0.25 lbs (115 g)

 Capacity
 500 GB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate Synchronous (maximum) 600 MB/s (Drive Capability)

Seek TimeSingle Track1.5 ms ~ 2 ms(typical reads, including settling)Average11 ms ~ 13 msMaximum18 ms ~ 22 ms

CacheUp To 32 MBRotational Speed7200 rpmLogical Blocks976,773,168

**Operating Temperature** 32° to 140° F (0° to 60° C) [top cover temp] **Features** ATA Security, S.M.A.R.T., NCQ, Ultra DMA

## Technical Specifications - Storage and Drives

500 GB Hybrid, 8 GB cache **Drive Weight** 0.198 lbs (90 g) ~ 0.20 lbs (92 g)

 Capacity
 500 GB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer RateSynchronous (maximum)600 MB/sSeek Time<br/>(typical reads, including<br/>settling)Single Track<br/>Average<br/>Maximum1.5 ms ~ 2 ms<br/>12 ms ~13 ms<br/>22 ms ~ 32 ms

CacheUp to 128MBRotational Speed5400 rpmLogical Blocks976,773,168

**Operating Temperature** 32° to 140° F (0° to 60° C) [case temp] **Features** ATA Security, S.M.A.R.T., NCQ, Ultra DMA

500 GB 7200 rpm SATA SED FIPS\* 140-2 compliant Hard Drive 
 Drive Weight
 0.21 lbs (95g)

 Capacity
 500 GB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate Synchronous (maximum) 600 MB/s (Drive Capability)

Seek TimeSingle Track1.5 ms(typical reads, including<br/>settling)Average12 msMaximum18-22 ms

Cache 32 GB
Rotational Speed 7200 rpm
Logical Blocks 976,773,168

**Operating Temperature** 32° to 140° F (0° to 60° C) [top cover temp]

Features ATA Security; TCG Opal 2.x, FIPS, S.M.A.R.T., NCQ, Ultra DMA

\* FIPS-certified, hardware-based AES-256 encryption image.

500 GB 7200 rpm SATA Self Encrypting Drive **Drive Weight** 0.21 lbs (95g) **Capacity** 500 GB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate Synchronous (maximum) 600 MB/s (Drive Capability)

Seek TimeSingle Track2 ms(typical reads, including settling)Average12 msMaximum18-22 ms

Cache32 MBRotational Speed7200 rpmLogical Blocks976,773,168

**Operating Temperature** 32° to 140° F (0° to 60° C) [case temp]

Features ATA Security, TCG Opal v1.00, S.M.A.R.T., NCQ, Ultra DMA

## Technical Specifications - Storage and Drives

256 GB M2 2280 SATA-3

**Self-Encrypting** 

Drive (Opal 2) TLC Solid **State Drive** 

**Drive Weight** 0.02 lb (<10 g) Capacity 256 GB

Height 0.14 in (3.58 mm)- 0.09 in (2.23 mm)

Width 0.87 in (22 mm) Interface **ATA-8, SATA 3.0** 

**Performance Maximum Sequential Read Maximum Sequential Write** 

> UP to 515 MB/s Up to 530 MB/s

**Logical Blocks** 500,118,192

32° to 158°F (0° to 70°C) [ambient temp] **Operating Temperature** 

ATA Security; TCG Opal 2.0, DIPM; TRIM; DEVSLP **Features** 

512 GB M2 2280 SATA-3

Self-Encrypting

Drive (Opal 2) TLC Solid **State Drive** 

**Drive Weight** 0.022 lb (<10 g)

Capacity Height 0.14 in (3.7 mm Width 0.87 in (22 mm) XG4 NVMe Generation

**NAND Type** TLC Form-Factor (I/O) M.2 2280 Interface PCIe GEN3X4

**Performance Maximum Sequential Maximum Sequential Write** 

Read

Up to 2400MB/s Up to 1500MB/s

**Logical Blocks** 2,000,409,264

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** ATA Security, L1.2

HP Z Turbo Drive 512 GB, Drive Weight M.2 NVMe MLC Solid State Capacity

Drive

0.022 lb. (10 q)

512 GB

Height 0.14 in (3.7 mm) Width 0.87 in (22 mm) Generation SM951 NVMe

**NAND Type** MLC Form-Factor (I/O) M.2 2280

Interface PCIe NVMe Gen3X4

**Performance Maximum Sequential Read Maximum Sequential Write** 

> Up to 3000 MB/s Up to 1500 MB/s

**Logical Blocks** 1,000,215,216

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** ATA Security (Option); TRIM; L1.2

## Technical Specifications - Storage and Drives

HP Z Turbo Drive 256 GB, M.2 NVMe MLC Solid State

Drive

 Drive Weight
 0.02 lb (10 g)

 Capacity
 256 GB

 Height
 0.09 in (2.23 mm)

 Width
 0.87 in (22 mm)

**Generation** MLC **NAND Type** M.2 2280

Form-Factor (I/O) PCIe NVMe Gen3X4

Performance Maximum Sequential Read Maximum Sequential Write

**Logical Blocks** 500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (Option);TRIM; L1.2

HP Z Turbo Drive 256 GB, Drive Weight
M.2 NVMe TLC Solid State Capacity
Drive

**Drive Weight** 0.022 lb (<10 g)

Capacity 256 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Generation
 SM951 NVMe

NAND Type TLC
Form-Factor (I/O) M.2 2280
Interface PCIe GEN3X4

Performance Maximum Sequential Maximum Sequential Write

Read

**Logical Blocks** 500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (Option), TRIM; L1.2

HP Z Turbo Drive 512 GB, Drive Weight
M.2 NVMe TLC Opal 2
Solid State Drive
Capacity
Solid State Drive

**Drive Weight** 0.022 lb (<10 g)

Capacity 256 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Generation
 SM951 NVMe

NAND Type TLC
Form-Factor (I/O) M.2 2280
Interface PCIe GEN3X4

Performance Maximum Sequential Maximum Sequential Write

Read

**Logical Blocks** 500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security,TRIM; L1.2



# Technical Specifications - Storage and Drives

HP Z Turbo Drive 1 TB, M.2 NVMe MLC Solid State Drive

**Drive Weight** 0.022 lb (<10 g)

**Capacity** 256 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Generation
 SM951 NVMe

NAND Type MLC
Form-Factor (I/O) M.2 2280
Interface PCIe GEN3X4

Performance Maximum Sequential Maximum Sequential Write

Read

**Logical Blocks** 500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security, TRIM; L1.2



<sup>\*</sup>For hard drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) disk is reserved for system recovery software.

# **Technical Specifications - Security**

## **SECURITY**

**HP Fingerprint Sensor Mobile Voltage Operation** 3.0V-3.6V Single Supply

**Operating Temperature** 14° - 167°F (-10° - 75°C)

**Current consumption** 36mA

image

Low latency wait for

finger

950 uA

Capture rate 3000 lines/sec

**ESD Resistance** IEC 6100-4-2 4B (+/-15KV)

**Detection Matrix** 200\*1 (plus another secondary line); 508 dpi, sensor area 12\*3 mm



Technical Specifications – Networking

### **NETWORKING/COMMUNICATION**

**Power** 

Intel® I219-LM Gigabit Network Connection (vPro configurations) Ethernet Features 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-

14)

100 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses

13-14)

100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses

21-30)

1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023.

Clauses 40)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10 and

100 Mbit/s

IEEE 802.1p QoS (Quality of Service) Support

IEEE 802.1q VLAN support

IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)

IEEE 802.3az EEE(Energy Efficient Ethernet)

Jumbo Frame 9K

Auto MDI/MDIX Crossover cable detection ACPI compliant - multiple power modes

ManagementEnergy Detect Low Power Mode(Green Ethernet)PerformanceTCP/IP/UDP Checksum Offload (configurable)

Features Protocol Offload( ARP & NS)

Large send offload and Giant send offload

Receiving Side Scaling MACSec Offload (802.3ae)

Intel® vPro iSCSI Boot

RSS is kernel based support (e.g. in Win Server 2013)

Ultra Low Power at cable disconnect (<1mW) enables platform

support for connected standby.

**Manageability** Wake-on-LAN from standby and hibernation (Magic Packet and

Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet

only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB

(802.3x, clause 30))

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

Interface PCI Express 1.1 x1 to fully support ASPM LOs/L1 and CLKREQ.

**NOTE:** Intel® I219-LM Gigabit interface is not PCIe compliant. It

operates at half of PCIe specification V1.1 (2.5GT/S) speed.

NIC Device Driver Name Intel® Ethernet Network Connection I219-LM



## Technical Specifications – Networking

Intel® 1219-V Gigabit Network Connection (Non-vPro configurations) Ethernet Features 10 Mbit/s operation (10BASE-T; IEEE 802.3; IEEE 802.3 clauses

13-14)

100 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3

clauses 13-14)

100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3

clauses 21-30)

1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023.

Clauses 40)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10

and 100 Mbit/s

IEEE 802.1p QoS (Quality of Service) Support

IEEE 802.1q VLAN support

IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)

IEEE 802.3az EEE(Energy Efficient Ethernet)

Jumbo Frame 9K

Auto MDI/MDIX Crossover cable detection

**Power** ACPI compliant - multiple power modes

ManagementEnergy Detect Low Power Mode(Green Ethernet)PerformanceTCP/IP/UDP Checksum Offload (configurable)

Features Protocol Offload( ARP & NS)

Large send offload and Giant send offload

Receiving Side Scaling MACSec Offload (802.3ae)

Intel Non-vPro iSCSI Boot

Manageability Wake-on-LAN from standby and hibernation (Magic Packet and

Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet

only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB

(802.3x, clause 30))

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

Interface PCI Express 1.1 x1 to fully support ASPM LOs/L1 and CLKREQ.

NOTE: Intel 82579 PCIe interface is not PCIe compliant. It operates

at half of PCIe specification V1.1 (2.5GT/S) speed.

NIC Device Driver Name Intel 82579LM/82579V Ethernet Network Connection



## Technical Specifications – Networking

#### HP lt4132 LTE/HSPA+ 4G Mobile Broadband Module

Technology/Operating

LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3) MHz,

bands

850 (Band 5), 2600 (Band 7), 900 (Band 8) MHz,

800 (Band 20), 700 (Band 28) MHz.

HSPA+: 2100 (Band 1), 1900 (Band 2), 850 (Band 5), 900 (Band 8) MHz E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8) MHz

Wireless protocol

standards

3GPP Release 10 LTE Specification CAT.4, 20MHz BW

WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification E-GPRS: Class B, Multi-slot class 12, coding schemes CS1 - CS4

and MSC1 - MSC9

**GPS** Standalone, A-GPS (MS-B and LTO)

**GPS bands** 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz

Maximum data rates LTE: 150 Mbps (Download), 50 Mbps (Upload)

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)

Maximum output power

LTE: 23 dBm

HSPA+: 23.5 dBm

E-GPRS 1900/1800: 26 dBm E-GPRS 900/850: 27 dBm GPRS 1900/1800: 29.5 dBm GPRS 900/850: 32.5 dBm

Maximum power consumption

LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average) E-GPRS: 2,600 mA (peak); 500 mA (average)

**Form Factor** 

M.2, 3042-S3 Key B

Weight 6 g

**Dimensions** 42 x 30 x 2.3 mm

(Length x Width x Thickness)

\* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

#### **HP hs3210 HSPA+ Mobile Broadband Module\***

Technology/Operating bands

HSPA+: 2100 (Band1), 1900 (Band 2), 850 (Band 5), 900 (Band 8) MHz E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 MHz (Band 5), 900 (Band 8) MHz

Wireless protocol WCDMA R99, 3GPP Release 5, 6 and 7 UMTS Specification

standards

E-GPRS: Class B, Multi-slot class 33, coding schemes CS1 - CS4 and MSC1 - MSC9

Maximum data rates HSPA+: 21.6 Mbps (Download), 5.76 Mbps (Upload)

E-GPRS: 296 kbps (Download), 236.8 kbps (Upload) GPRS: 107 kbps (Download), 85.6 kbps (Upload)

Maximum output power HSPA+: 24 dBm

E-GPRS 1800/1900: 26 dBm E-GPRS 850/900: 27 dBm



# Technical Specifications - Networking

GPRS 1800/1900: 30 dBm GPRS 850/900: 33 dBm

Maximum powerHSPA+: 1,100 mA (peak); 800 mA (average)consumptionE-GPRS: 2,800 mA (peak); 700 mA (average)

Form Factor M.2, 2242-S3 Key B

Weight 6 g

**Dimensions** 1.65 x 8.66 x 0.09 in (42 x 22 x 2.38 mm)

(Length x Width x Thickness)

\* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors.

### HP lt4120 Qualcomm® Snapdragon™ X5 LTE Mobile Broadband Module

Technology/Operating

LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3),

bands

1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 17 lower),

800 (Band 20), 700 (Band 28).

HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4),

850 (Band 5), 900 (Band 8) MHz

EV-DO: 850 (BCO), 1900 (BC1) MHz (Only work with Verizon network) E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8)

MHz

Wireless protocol

standards

3GPP Release 10 LTE Specification CAT.4, 20MHz BW WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

1xEVDO Release O, A and B.

E-GPRS: Class B, Multi-slot class 12, coding schemes CS1 - CS4

and MSC1 - MSC9

**GPS** Standalone, A-GPS (MS-A, MS-B and XTRA)

**GPS bands** 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz

Maximum data rates LTE: 150 Mbps (Download), 50 Mbps (Upload)

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21 Mbps (Download), 5.76 Mbps (Upload)

CDMA 1xRTT: 153.6 kbps (Download), 153.6 kbps (Upload) EVDO Rel.A: 3.1 Mbps (Download), 1.8 Mbps (Upload) EVDO Rel.B: 14.7 Mbps (Download), 5.4Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)

Maximum output power LTE: 23 dBm

HSPA+: 23.5 dBm 1xRTT/EVDO: 24dBm E-GPRS 1900/1800: 26 dBm E-GPRS 900/850: 27 dBm GPRS 1900/1800: 29.5 dBm GPRS 900/850: 32.5 dBm

Maximum power consumption

LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)

1xRTT/EVD0: 1,000 mA (peak); 700 mA (average) E-GPRS: 2,800 mA (peak); 500 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 6.2 g



# HP ZBook 14u G4 Mobile Workstation

# Technical Specifications – Networking

**Dimensions** 

Thickness)

(Length x Width x

42 x 30 x 2.3 mm

Intel® Dual Band Wireless-AC 8265 802.11 AC/a/b/g/n (2x2) WiFi + Bluetooth® 4.2 Combo Adaptor\* (vPro)

**Wireless LAN Standards** 

IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11n Wi-Fi certified

Interoperability

Frequency Band 802.11b/g/n

2.402 - 2.482 GHz

**Note:** The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise

disable those channels

802.11a 4.9 - 4.95 GHz (Japan)

5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz

Note: Indonesia only supports 5.725 - 5.825 GHz

(CH149 - CH161)

**Data Rates** 

- 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11b: 1, 2, 5.5, 11 Mbps
- 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
- 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation

Direct Sequence Spread Spectrum CCK, BPSK, QPSK, 16-QAM, 64-QAM, 256-QAM

Security<sup>1</sup>

- IEEE and Wi-Fi compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX Lite
- WAPI

**Network Architecture** 

Models

Roaming

Output Power<sup>2</sup>

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

IEEE 802.11 compliant roaming between band Access Points

- 802.11b: +16dBm minimum
- 802.11g: +14dBm minimum
- 802.11a: +14dBm minimum
- 802.11n HT20(2.4GHz): +13dBm minimum
- 802.11n HT40(2.4GHz): +13dBm minimum



## Technical Specifications – Networking

802.11n HT20(5GHz): +12dBm minimum
 802.11n HT40(5GHz): +12dBm minimum

**Power Consumption** Transmit: 2.0 Watts (max)

Receive: 1.6 Watts (max)

Idle mode (PSP): 180 mW (WLAN Associated) Idle mode: 50 mW (WLAN unassociated) Connect Standby: 10mW (WLAN + BT)

Radio disabled: 5 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity**<sup>3</sup> 802.11b, 1Mbps: -94dBm maximum

802.11b, 11Mbps: -86dBm maximum 802.11g, 6Mbps: -88dBm maximum 802.11g, 54Mbps: -74dBm maximum 802.11a, 6Mbps: -88dBm maximum 802.11a, 54Mbps: -74dBm maximum 802.11n, MCS07: -69dBm maximum 802.11n, MCS15: -66dBm maximum 802.11ac, 1SS, MCS-0: -86dBm maximum 802.11ac, 2SS, MCS-9: -61dBm maximum 802.11ac, 2SS, MCS-9: -58dBm maximum 802.11ac, 2SS, MCS-9: -58dBm maximum

Antenna Type High efficiency antenna with spatial diversity, mounted in the

display enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** Type 2230 : 2.3 x 22.0 x 30.0 mm

0r

Type 1630: 2.3 x 16.0 x 30.0 mm

Weight Type 2230: 2.8q

0r

Type 1630 : 2g

Operating Voltage 3.3v +/- 9%

**Temperature**Operating
14° to 158° F (-10° to 70° C)
Non-operating
-40° to 176° F (-40° to 80° C)

**Humidity** Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

**Altitude** Operating Non- 0 to 10,000 ft (3,048 m)

operating 0 to 50,000 ft (15,240 m)

LED Activity

LED Amber – Radio OFF; LED White – Radio ON

# Technical Specifications – Networking

HP Integrated Module with Bluetooth®

4.2 Wireless Technology

**Bluetooth® Specification** 4.2 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Channels Legacy: 0~79 (1 MHz/CH)

BLE: 0~39 (2 MHz/CH)

**Data Rates and Throughput** Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps

BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps,

voice channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth

device with a maximum transmit power of +4 dBm for BR and EDR

Receiver Sensitivity

Modulation	0.01% BER	0.001% BER
GFSK	-80 dBm	-70 dBm
π/4-DQPSK	-80 dBm	-70 dBm
8DPSK	-80 dBm	-70 dBm

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Antenna Internally integrated within module

Range Legacy Up to 33 ft (10 m)

BLE Up to 99 ft (30 m)

**Electrical Interface** USB 2.0 compliant

Bluetooth® Software Supported Microsoft Windows Bluetooth Software

Link TopologyPoint to Point, Multipoint Pico Nets up to 7 slavesSecurityFull support of Bluetooth Security ProvisionsPower ManagementMicrosoft Windows ACPI, and USB Bus Support

Certifications

Self-configurable to optimize power conservation in all operating

modes, including Standby, Hold, Park, and Sniff

**Security** All necessary regulatory approvals for supported countries,

including:

FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power managementETS 300 328, ETS 300 826certificactionsLow Voltage Directive IEC950

UL, CSA, and CE Mark

**Certifications** Serial Port Profile (SPP)1

**Bluetooth® Profiles Supported** Service Discovery Application Profile (SDAP)

Dial-Up Networking (DUN)1,2

Generic Object Exchange Profile (GOEP)1,2

Object Push Profile (OPP)1,2

Hard Copy Cable Replacement (HCRP)1,2 Personal Area Networking Profile (PAN)1,2 Human Interface Device Profile (HID)1,2

Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)
Audio Video Remote Control Profile (AVRCP)



# Technical Specifications - Networking

# Bluetooth® V4.2 support feature

V4.2: ESR8 compliant, LE Secure Connection – Basic.

- Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.

Intel® Dual Band Wireless-AC 8265 802.11 AC/a/b/g/n (2x2) WiFi + Bluetooth® 4.2 Combo Adaptor\* (non-vPro) Wireless LAN Standards

IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac

Interoperability
Frequency Band

Wi-Fi certified 802.11b/g/n

#### 2.402 - 2.482 GHz

Note: The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels

#### 802.11a

- 4.9 4.95 GHz (Japan)
- 5.15 5.25 GHz
- 5.25 5.35 GHz
- 5.47 5.725 GHz
- 5.825 5.850 GHz

Note: Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)

Antenna Structure Data Rates 2 transmit; 2 receive (2x2)

802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11b: 1, 2, 5.5, 11 Mbps

802.11q: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: card will support rates for NSS=1 and NSS=2 for RX and TX for 20 and 40 MHz channels. Short and long guard interval shall be

supported.

802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and

80MHz)

**Modulation** Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security<sup>1</sup>

- IEEE and Wi-Fi compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication

# Technical Specifications – Networking

- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX Lite
- WAPI

**Network Architecture** 

Output Power<sup>2</sup>

Models Roaming Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

IEEE 802.11 compliant roaming between access points

802.11b: +16dBm minimum

802.11g: +14dBm minimum

802.11a: +14dBm minimum

802.11n HT20(2.4GHz): +13dBm minimum

802.11n HT40(2.4GHz): +13dBm minimum

802.11n HT20(5GHz): +12dBm minimum

802.11n HT40(5GHz): +12dBm minimum

802.11ac 80MHz(5GHz): +11dBm minimum

**Power Consumption** Transmit: 2.0 W (max)

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated) Idle mode: 60 mW (WLAN unassociated)

Radio disabled: 30 mW

ACPI and PCI Express compliant power management **Power Management** 

802.11 compliant power saving mode

Receiver Sensitivity<sup>3</sup> 802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -

85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm

(48 Mbps), -74 dBm (54 Mbps)

802.11b:-95 dBm (1 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -

88 dBm (11 Mbps)

802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -

85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm

(48 Mbps), -74 dBm (54 Mbps)

802.11n:-69 dBm (150 Mbps), -66 dBm (300 Mbps)

Antenna type High efficiency antenna with spatial diversity, mounted in the

display enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the

card to support WLAN MIMO communications and Bluetooth

communications

PCI-Express Half-MiniCard **Form Factor** 

Dimensions 0.134 x 1.06 x 1.18 in (3.4 x 26.8 x 30 mm)

Weight 3.1g

**Operating Voltage** 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

> Non-operating -40° to 176° F (-40° to 80° C)

**Humidity** Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

## Technical Specifications – Networking

Altitude Operating 0 to 10,000 ft. (3,048 m) Non-operating 0 to 50,000 ft. (15,240 m)

LED Amber - Radio OFF; LED White - Radio ON

**LED Activity** 

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

#### HP Integrated Module with Bluetooth® 4.2 Wireless Technology

**Bluetooth Specification** 4.0+EDR Compliant **Frequency Band** 2402 to 2480 MHz

**Number of Available Channels** 79 (1 MHz) available channels

**Data Rates and Throughput** 3 Mbps data rate; throughput up to 2.17 Mbps

Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric or 1306.9 kbps symmetric

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth

device with a maximum transmit power of +4 dBm for BR and EDR

**Receiver Sensitivity** Better than -20 dBM at 0.1 % raw bit error rate

**Power Consumption** Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Antenna Internally integrated within module

Range Up to 33 ft. (10 m) **Electrical Interface** USB 2.0 compliant

Microsoft Windows Plug and Play compliant

Bluetooth® Software

Supported

Microsoft Windows Bluetooth Software

**Broadcom Bluetooth for Windows** 

Link Topology Point to Point, Multipoint Pico Nets up to 7 slaves **Security** Full support of Bluetooth Security Provisions Microsoft Windows ACPI, and USB Bus Support **Power Management** 

Self-configurable to optimize power conservation in all operating

modes, including Standby, Hold, Park, and Sniff

Certifications All necessary regulatory approvals for supported countries,

including:

FCC (47 CFR) Part 15C, Section 15.247 & 15.249

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth® Profiles Supported Serial Port Profile (SPP)1

Service Discovery Application Profile (SDAP)

Dial-Up Networking (DUN)1,2

Generic Object Exchange Profile (GOEP)1,2

Object Push Profile (OPP)1,2 File Transfer Profile (FTP) Synchronization Profile (SYNC)

Hard Copy Cable Replacement (HCRP)1,2 Personal Area Networking Profile (PAN)1,2



## Technical Specifications – Networking

Human Interface Device Profile (HID)1,2 FAX Profile (FAX) Basic Imaging Profile (BIP)<sup>2</sup> Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)

- 1. Indicates the profile is supported by Microsoft Windows XP SP2
- 2. Indicates the profile is part of Windows Vista
- \* Wireless access point and internet service required. Availability of public wireless access points limited.

Intel® Dual Band Wireless- Wireless LAN AC 3168 802.11 ac (1x1) WiFi and Bluetooth® 4.2 Combo Adapter (non-vPro)

**Standards** 

IEEE 802.11a IEEE 802.11b

IEEE 802.11q IEEE 802.11n

Interoperability **Frequency Band**  IEEE 802.11ac Wi-Fi certified

802.11b/g/n 2.402 - 2.482 GHz

> Note: The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

#### 802.11a/n

- 4.9 4.95 GHz (Japan)
- 5.15 5.25 GHz
- 5.25 5.35 GHz
- 5.47 5.725 GHz
- 5.825 5.850 GHz

Note: Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)

#### **Data Rates**

- 802.11b: 1, 2, 5.5, 11 Mbps
- 802.11q: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
- 802.11ac: MCS0 ~ MCS7, (1SS) (20MHz, 40MHz, and 80MHz)

#### Modulation

**Direct Sequence Spread Spectrum** 

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

### Security<sup>1</sup>

- IEEE and Wi-Fi compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX Lite
- WAPI



## Technical Specifications – Networking

Network Architecture Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

**Roaming** IEEE 802.11 compliant roaming between access points

Output Power<sup>2</sup> • 802.11b: +16dBm minimum

802.11g: +14dBm minimum802.11a: +14dBm minimum

802.11n HT20(2.4GHz): +13dBm minimum
 802.11n HT40(2.4GHz): +13dBm minimum
 802.11n HT20(5GHz): +12dBm minimum
 802.11n HT40(5GHz): +12dBm minimum
 802.11ac 80MHz(5GHz): +11dBm minimum

**Power Consumption** Transmit: 2.0 W (max)

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)
Idle mode: 60 mW (WLAN unassociated)

Radio disabled: 30 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity³** 802.11b, 1Mbps: -94dBm maximum

802.11b, 11Mbps: -86dBm maximum 802.11g, 6Mbps: -88dBm maximum 802.11g, 54Mbps: -74dBm maximum 802.11a, 6Mbps: -86dBm maximum 802.11a, 54Mbps: -72dBm maximum 802.11n, MCS07: -69dBm maximum 802.11n, MCS15: -66dBm maximum 802.11ac, 1SS, MCS-0: -86dBm maximum 802.11ac, 2SS, MCS-9: -61dBm maximum 802.11ac, 2SS, MCS-9: -58dBm maximum

**Antenna type** High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** Type 2230 : 2.3 x 22.0 x 30.0 mm

0r

Type 1630 : 2.3 x 16.0 x 30.0 mm

**Weight** Type 2230 : 2.8g

Operating Voltage

Ur

Type 1630 : 2g 3.3v +/- 9%

**Temperature** Operating 14° to 158° F (-10° to 70° C)

Non-operating 40° to 176° F (-40° to 80° C)

**Humidity** Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

**Altitude** Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

**Near Field Communications (NFC)** 

**Controller** HP Module with NXP NFC Controller NPC100



## Technical Specifications - Networking

**Supports** • Windows 8, Proximity Events

Windows 7, PC/SCNFC Forum Compliant

• Near Field Communications Controller

**Dimensions** Module 25 mm by 10 mm by 2.0 mm

(LxWxH)

Chipset NPC100 System interface I2C

NFC RF standards standards ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092

ECMA-340 NFCIP-1 Target and Initiator ECMA-320 NFCIP-2

**NFC Forum Support** 

Taq

Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2

Reader (PCD-VCD) Mode(1) ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 MIFARE

1K MIFARE 4K MIFARE DESFire FeliCa Jewel and Topaz cards

Card Emulation (PICC-VICC)

Mode<sup>1</sup> ISO/IEC 14443 A ISO/IEC 14443 B and B' MIFARE FeliCa

Frequency 13.56 MHz

**NFC Modes Supported** Reader/Writer, Peer-to-Peer **Raw RF Data Rates** 106, 212, 424, 848 kbps

Operating temperature

0°C to 70°C

Storage temperature -20°C to 125°C

**Humidity** 10-90% operating 5-95% non-operating

**Supply Operating** 

voltage

2.97 to 5.5 Volts

**I/O Voltage** 1.8V or 3.3V

**Power Consumption** Booster enable, VBAT= 3.3V.

VCC\_BOOST = 5V)
Mode Power
Consumption,

Typical<sup>2</sup> Polling 7.3 mA Detected Test Tag Type 1 Total 283.8 mA Net Module 236.8 mA Detected Test Tag Type 2 Total 288.8 mA Net Module 241.8 mA Detected Test Tag Type 3 Total 287.7 mA Net Module 240.7 mA

Tag Type 3 Total 287.7 mA Net Module 240.7 mA
Detected Test Tag Type 4 Total 282.3 mA Net Module

235.3 mA

Antenna connector

0.5mm pitch, 7 connector FPC. Antenna matching is external to module.

**Notes** 

1. With application or UICC support

2. Actual Power Consumption is dependent on NFC antenna and matching circuit and on the particular polling sequence and period configured.

Technical Specifications - Audio and Multimedia

### **AUDIO/MULTIMEDIA – BANG & OLUFSEN**

Hardware Implementation Conexant CX7501

**Function Key** Volume up, volume down, and mute

**Volume Controls** 

Full Duplex Yes
Microphone In Stereo
Headphone/Line Out Stereo

**Integrated Microphone** Yes, dual digital microphone array when equipped with optional webcam

**Audio Output Quality** Frequency Response 20 Hz - 20 kHz

Signal to Noise Ratio 106dB (DAC), 102dB (ADC)

**Total Harmonic** 91dB THD+n on LineOut/HP (0.003%)

Distortion

Noise Floor -110 dB

Play Sampling Rate(s) Up to 192kHz

Record Sampling Rate(s) Up to 96kHz

DAC 16, 20 or 24-bit

ADC 16, 20 or 24-bit

Internal Stereo Speaker Power Rating 2 Watts

**Impedance** 4 ohms

### Technical Specifications - Power

#### **POWER**

HP 150W Slim Smart AC Adapter **Dimensions** 6.02 x 2.60 x .87 in (153 x 66 x 22 mm)

 Weight
 0.70 lbs (320 g)

 Input
 100 to 240 VAC

Input Efficiency 88% min at 115 VAC

Input frequency range 47 to 63 Hz

Input AC current 2.9 A at 90 VAC, 1.45 A at 180 VAC

Output Output power 150W DC output 19.5V

Hold-up time 5 msec at 115 VAC input

Output current limit <16A, Over voltage protection- 29V max

automatic shutdown

**Connector** 3 pin/grounded, mates with interchangeable cords **Environmental Design** 0perating 32° to 104° F (0° to 40° C)

temperature

Non-operating (storage) -4° to 149° F (-20° to 65° C)

temperature

Altitude 0 to 10,000 ft (0 to 3,048 m)

Humidity 20% to 80% Storage Humidity 10% to 90%

EMI and Safety Certifications CE Mark- full compliance with LVD and EMC directives; Worldwide safety standards- IEC950, EN60950, UL1950, Class 1, SELV; Agency approvals- C- UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCIB, NOM-1 NYCE; MTBF- over 200,000 hours at 25°C ambient condition.

HP Long Life 9-cell Polymer Battery (90 WHr) **Dimensions** (H x W x L) 0.47 x 4.33 x 10.2 in (1.2 x 11 x 26cm)

Weight (max) 1.12lb (420g)
Cells/Type 9-cell; Polymer

**Energy** Voltage 11.4V
Amp-hour capacity 7.905Ah

Watt-hour capacity 90Wh

**Temperature** Operating (Charging) 32° to 113° F (0° to 45° C)

Operating (Discharging) 14° to 140° F (-10° to 60° C) Non-operating -4° to 140° F (-20° to 60° C)

Non-operating -4 to 140 1 (-20 to

**Battery Re-Charge Time** System in OFF or Standby 3 hours

Mode

System ON 3 to 5 hours

Fuel Gauge LED No
Warranty\* 3 year
Compatible with optional N/A

**Travel Battery** 

\* 3-year platform warranty is required for a 3-year Long Life Battery warranty.

### Technical Specifications - Environmental Data

### **ENVIRONMENTAL DATA**

# Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- US Federal Energy Management Program (FEMP)
- EPEAT® GOLD registered in the United States. See <a href="http://www.epeat.net">http://www.epeat.net</a> for registration status in your country.

#### **System Configuration**

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".

#### Energy Consumption (in accordance with US ENERGY STAR® test method)

STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Sort idle)	11.20 W	10.51 W	11.24 W
Normal Operation (Long idle)	6.70 W	6.30 W	6.37 W
Sleep	1.13 W	1.12 W	1.14 W
Off	0.41 W	0.43 W	0.42 W

#### Note:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	38 BTU/hr	36 BTU/hr	38 BTU/hr
Normal Operation (Long idle)	23 BTU/hr	22 BTU/hr	22 BTU/hr
Sleep	4 BTU/hr	4 BTU/hr	4 BTU/hr
Off	1.4 BTU/hr	1 BTU/hr	1 BTU/hr

\*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

### Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

Typically Configured – Idle Fixed Disk – Random writes

### Longevity and Upgrading

Sound Power (L <sub>WAd</sub> , bels)	Sound Pressure (L <sub>pAm</sub> , decibels)
3.2	22
3.2	21

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 3 USB ports
- 2 Thunderbolt<sup>™</sup> 3 ports
- 1 2.5" Storage Bay Drive
- 2 M.2 SATA SED Solid State Drives



### **Technical Specifications - Environmental Data**

- 1 Smart Card reader
- 4 SODIMM memory slots
- 1 HDMI 1.4 port

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

#### **Batteries**

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Battery size: 6-cell high capacity Lithium-Ion battery (optional 8 cell available)

Battery type:

#### **Additional Information**

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 0.0% post-consumer recycled plastic (by wt.)
- This product is 95.6% recycle-able when properly disposed of at end of life.

#### **Packaging Materials**

External:	PAPER/Corrugated	383 g
Internal:	PLASTIC/Polyethylene Expanded - EPE	90 g
	PLASTIC/Polyethylene low density - LDPE	10 g
	PLASTIC/Polypropylene - PP	5 g

The plastic packaging material contains at least 81.5% recycled content.

The corrugated paper packaging materials contains at least 80 % recycled content.

#### **Material Usage**

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehvde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds



### Technical Specifications - Environmental Data

- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

#### **Packaging Usage**

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

# End-of-life Management and Recycling

HP Inc.offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/go/reuse-recycle">http://www.hp.com/go/reuse-recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the HP Inc. web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a>. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

# HP Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:

**Global Citizenship Report** 

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates:

http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

Technical Specifications - Environmental Data

## **COUNTRY OF ORIGIN**

China



Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part #
Memory	HP 4GB DDR4-2400 SODIMM (Core processors only)	Z4Y84AA
	HP 8GB DDR4-2400 SODIMM (Core processors only)	Z4Y85AA
	HP 16GB DDR4-2400 SODIMM (Core processors only)	Z4Y86AA
	HP 8GB DDR4-2133 EEC SODIMM (Xeon® processors only)	V1D58AA
	HP 16GB DDR4-2133 EEC SODIMM (Xeon® processors only)	V1D59AA
_		
Cases	HP Executive 15.6 Black Top Load	P6N18AA
	HP Business Case (up to 15.6")	H5M92AA
Docking	HP ZBook Dock with Thunderbolt™ 3	P5Q58AA
_	HP Executive Travel Hub	TOK29AA
	HP Travel Hub	TOK30AA
	HP 3005pr USB 3.0 Port Replicator w/ USB-C Adapter	Y4H06AA
	HP USB-Type C™ Elite Dock	X7W54AA
Input/Output -	HP Comfort Grip Wireless Mouse	H2L63AA
Mice	HP 3-Button Laser Mouse	H4B81AA#xxx
	HP Ultra Mobile Wireless Mouse	H6F25AA#xxx
	HP X4000 Bluetooth® Mouse	H3T50AA#xxx
	HP Slim Bluetooth® Mouse	F3J92AA#xxx
	HP Ultrathin Wireless Mouse	L9V78AA
	HP Wireless (Link-5) Keyboard	T6U20AA
	HP Slim Wireless Keyboard and Mouse	T6L04AA#xxx
	HP Slim USB Keyboard and Mouse	T6T83AA
	HP Stereo 3.5mm Headset	T1A66AA
	HP Stereo USB Headset	T1A67AA
	HP 150W Slim Smart AC Adapter (4.5mm)	W2F74AA
Adapters	HP Wireless display adapter	J1V25AA#xxx
	HP USB-C to VGA Adapter	N9K76AA
	HP USB-C to DisplayPort Adapter	N9K78AA
	HDMI to DVI adapter	F5A28AA
	USB-C to TB1/TB2	Z4P20AA
Collaboration	HP Conferencing Keyboard	K8P74AA#xxx
	HP UC Speaker Phone	K7V16AA
	HP UC Wired Headset	K7V17AA
	HP UC Wireless Mono Headset	W3K08AA
	HP UC Wireless Duo Headset	W3K09AA
	HP External USB Optical Drive	F2B56AA



F3R97AA

TOY16AA

TOY15AA

# QuickSpecs

Storage - External HP 500GB 7200rpm HDD

**HP Essential Combination Lock** 

**HP Combination Lock** 

Options and Accessories (sold separately and availability may vary by country)

Jediage Ext	cinat in 300db / 2001pin inbb	136377111
Storage	HP 256GB TLC PCI-e 3x4 NVMe SSD (2280)	1FU87AA
	HP 256GB M2 PCIe NVME SSD (2280)	V3K66AA
	HP 512GB M2 PCIe NVME SSD (2280)	V3K67AA
Security	HP UltraSlim Keyed Cable Lock	H4D73AA
	HP Dual Head Cable Lock (Non-Master Key)	T1A64AA
	HP Dual Head Cable Lock (Master Key)	T1A65AA
	HP 15.6" Notebook PC Privacy Filter	J7H71AA

HP Keyed Cable lock
HP Keyed Cable Lock 10mm
T1A62AA

**NOTE:** External power supplies, power cords, cables and peripherals are not low halogen. Service parts obtained after purchase may not be low halogen.



# **Summary of Changes**

Date of change:	Version History:		Description of change:
April 21, 2017	From v1 to v2	Removed	Integrated Bluetooth compatibility with 4.0, 4.1



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